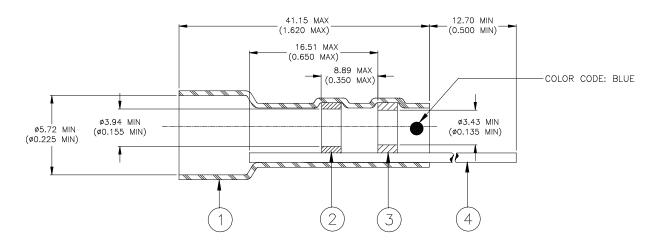
# **CUSTOMER DRAWING**



#### MATERIALS

1. INSULATION SLEEVE: Heat-shrinkable, transparent gray, radiation cross-linked modified thermoplastic.

- 2. SOLDER PREFORM WITH FLUX:
  - SOLDER: TYPE Sn63 per ANSI J-STD-006.
  - FLUX: TYPE ROL0 per ANSI J-STD-004.
- 3. MELTABLE INSERT: Thermally stabilized thermoplastic, Color blue.
- 4. BUSS WIRE: 20 AWG, Tin coated copper.

## APPLICATION

- 1. These parts are designed for use on tin or silver plated copper shields.
- 2. Raychem D-513 series Dielectric Barrier should be used on cables with low temperature insulation.
- 3. For selection guide and installation instructions, see below and sheet 2.

### SELECTION GUIDE

- 1. Determine maximum diameter of cable dielectric/primary insulation.
- 2. Select smallest D-513 Barrier having minimum I.D. greater than cable dielectric/ primary insulation diameter (See Table 1)
- 3. Select appropriate sleeve from Table 1.

TABLE 1.						
	Barriers					
Soldersleeve	Part Name	Min. I.D.	Color			
D-134-04 For Cable Dia. 2.29 – 5.46 (0.090 – 0.215)	D-513-05	1.27 (0.050)	White			
	D-513-06	1.52 (0.060)	Yellow			
	D-513-07	1.78 (0.070)	Blue			
	D-513-08	2.03 (0.080)	White			
	D-513-09	2.29 (0.090)	Yellow			

TE Connectivity, TE connectivity (logo), Raychem, and SolderSleeve are trademarks

E TE Ha			Vire and arnessing Products	TITI	LE : 20 AWG BUSS WIRE, SOLDERSLEEVE, PADDLECARD TERMINATOR				
Unless otherwise specified dimensions are in millimeters. Inches dimensions are in between brackets.					DOCUMENT NO.: <b>D-134-04</b>				
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ANGLES: N ROUGHNE: MICRON		TE Connectivity reserves the right to amend this drawing at any time. Users should evaluate the suitability of the product for their application.			Revision: 2		Issue Date: March 2020	
DRAWN BY: M. FORO	I BY: DATE: FORONDA 18-July-01			ECO: ECO-20-003568		SCALE: None	SIZE: A	SHEET: 1 of 3	

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## **CUSTOMER DRAWING**

### **INSTALLATION PROCEDURE:**

### A: SHIELDED CABLE

1. Strip cable and insert Barrier per Figure 1. End of Barrier should protrude from shield.

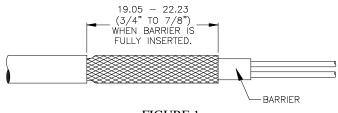
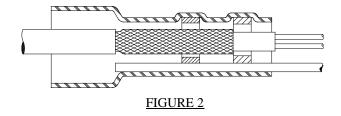


FIGURE 1 Multi-Conductor Cable Preparation

2. Slide sleeve over end of cable until meltable ring is over the end of shield, per Figure 2.

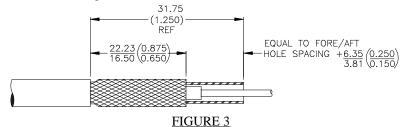


3. Place in Raychem IR-500 Heater, equipped with RG-2 Nose Cone, so that solder preform is at the notch. Apply heat until solder preform melts and flows.

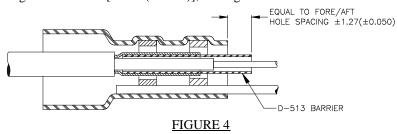
#### **B: COAXIAL CABLE**

This procedure must be followed when terminating coaxial cables with low temperature (less than 125°C) dielectric or high temperature dielectric with high shrink-back characteristics. It is recommended for all coaxial cable applications to reduce stress on center conductor/Paddlecard joint.

- 1. Cable is to be prepared as follows:
  - a). Remove  $44.45\pm3.18$  (1-3/4±1/8 inch) of cable jacket.
  - b). Remove all but 25.40 28.58 (1 to 1-1/8 inch) of shield and dielectric.
  - c). Insert D-513 Barrier of correct size (see Table 1) under shield. Trim excess braid as required so that cable looks as shown in Figure 3.



d). Place D-134 sleeve onto assembly so that extension of Barrier from end of sleeve is equal to Fore/Aft Hole Spacing of Paddlecard [±1.27 (±0.050)], see Figure 4.

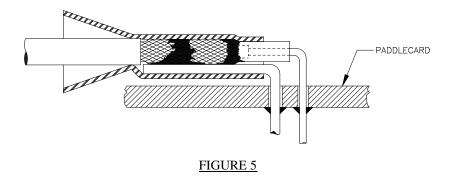


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# **CUSTOMER DRAWING**

- e). Place assembly into IR-500 so that solder preform is centered on notch in the RG-2 nose cone. Activate heater until solder melts and flows axially along the Buss Wire. It may be necessary to apply a small amount of heat to ends of sleeve to fully recover tubing. Remove from heat and allow to cool undisturbed until solder resolidifies.
- f). To mount terminated cable to Paddlecard, bend center conductor at end of Barrier and Buss Wire at end of sleeve and insert wires through holes in board (Figure 5).



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